

### 2.5V micropower shunt voltage reference

#### **Features**

- 2.50V typical output voltage
- Ultra low current consumption: 40µA typ.
- High precision @ 25°C
  - ±2% (standard version)
  - ±1% (A grade)
- High stability when used with capacitive loads
- Industrial temperature range: -40°C to +85°C
- 100ppm/°C maximum temperature coefficient

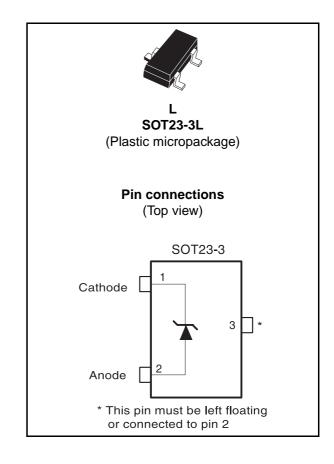
#### **Applications**

- Computers
- Instrumentation
- Battery chargers
- Switch mode power supply
- Battery operated equipment

### Description

The TS822 is a low power shunt voltage reference providing a stable 2.5V output voltage over the industrial temperature range (-40°C to +85°C). Availabe in SOT23-3 surface mount package, it can be designed in applications where space saving is critical.

The low operating current is a key advantage for power restricted designs. In addition, the TS822 is very stable and can be used in a broad range of application conditions.



## 1 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
I <sub>k</sub>	Reverse breakdown current	20	mA
I <sub>f</sub>	Forward current	10	mA
P <sub>d</sub>	Power dissipation <sup>(1)</sup> SOT23-3	360	mW
T <sub>stg</sub>	Storage temperature	-65 to +150	°C
ESD	Human body model (HBM) <sup>(2)</sup>	2	kV
ESD	Machine model (MM) <sup>(3)</sup>	200	V
T <sub>lead</sub>	Lead temperature (soldering, 10 seconds)	260	°C

<sup>1.</sup>  $P_d$  is calculated with  $T_{amb}$  = 25°C and  $R_{thja}$  = 340°C/W for the SOT23-3L package

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
I <sub>k-min</sub>	Minimum operating current	50	μΑ
I <sub>k-max</sub>	Maximum operating current	15	mA
T <sub>oper</sub>	Operating free air temperature range	-40 to +85	°C

<sup>2.</sup> Human body model: 100pF discharged through a  $1.5 \mathrm{k}\Omega$  resistor between two pins of the device, done for all couples of pin combinations with other pins floating.

Machine model: a 200pF cap is charged to the specified voltage, then discharged directly between two pins
of the device with no external series resistor (internal resistor < 5Ω), done for all couples of pin
combinations with other pins floating.</li>

## 2 Electrical characteristics

Table 3. TS822 (2% precision)  $T_{amb} = 25^{\circ}C^{(1)}$  (unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
	Reverse breakdown voltage	$I_k = 100 \mu A$	2.45	2.5	2.55	V	
V <sub>k</sub>	Reverse breakdown voltage tolerance	I <sub>k</sub> = 100μA -40°C < T <sub>amb</sub> < +85°C	-50 -66		50 66	mV	
	Minimum energting current	T = 25°C		40	50	μΑ	
I <sub>k-min</sub>	Minimum operating current	-40°C < T <sub>amb</sub> < +85°C			60		
$\Delta V_{ref}/\Delta T$	Average temperature coefficient	$I_k = 100 \mu A$		30	100	ppm/°C	
$\Delta V_k/\Delta I_k$	Reverse breakdown voltage change	I <sub>k-min</sub> < I <sub>k</sub> < 1mA -40°C < T <sub>amb</sub> < +85°C		0.4	1 1.2	mV	
	with operating current range	1mA < I <sub>k</sub> < 15mA -40°C < T <sub>amb</sub> < +85°C		2.5	8 10	IIIV	
В	Daviere static impodence	$I_k = I_{k-min}$ to 1mA -40°C < $T_{amb}$ < +85°C		0.4	1 1.2	Ω	
R <sub>ka</sub>	Reverse static impedance	I <sub>k</sub> = 1 to 15mA -40°C < T <sub>amb</sub> < +85°C		0.2	0.6 0.7	32	
K <sub>vh</sub>	Long term stability	$I_k = 100 \mu A, t = 1000 hrs$		120		ppm	
En	Wide band noise	$I_k = 100\mu A$ , $10Hz < f < 10kHz$		35		nV/√Hz	

<sup>1.</sup> Limits are 100% production tested at 25°C. Behavior at temperature range limits is guaranteed by correlation and design.

Table 4. TS822A (1% precision)  $T_{amb} = 25^{\circ}C^{(1)}$  (unless otherwise specified)

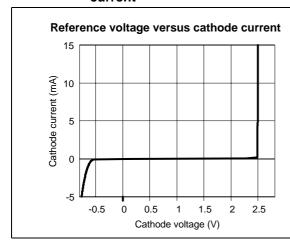
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
	Reverse breakdown voltage	I <sub>k</sub> = 100μA	2.475	2.5	2.525	V	
V <sub>k</sub>	Reverse breakdown voltage tolerance	I <sub>k</sub> = 100μA -40°C < T <sub>amb</sub> < +85°C	-25 -41		25 41	mV	
	Minimum operating current	T = 25°C		40	50	μΑ	
I <sub>k-min</sub>	Minimum operating current	-40°C < T <sub>amb</sub> < +85°C			60		
$\Delta V_{ref}/\Delta T$	Average temperature coefficient	I <sub>k</sub> = 100μA		30	100	ppm/°C	
$\Delta V_{\mathbf{k}}/\Delta_{\mathbf{lk}}$	Reverse breakdown voltage change	I <sub>k-min</sub> < I <sub>k</sub> < 1mA -40°C < T <sub>amb</sub> < +85°C		0.4	1 1.2	mV	
	with operating current range	1mA < I <sub>k</sub> < 15mA -40°C < T <sub>amb</sub> < +85°C		2.5	8 10	1111	
R <sub>ka</sub>	Reverse static impedance	$I_k = I_{k-min}$ to 1mA -40°C < $T_{amb}$ < +85°C		0.4	1 1.2	Ω	
		I <sub>k</sub> = 1mA to 15mA -40°C < T <sub>amb</sub> < +85°C		0.2	0.6 0.7	22	
K <sub>vh</sub>	Long term stability	$I_k = 100 \mu A, t = 1000 hrs$		120		ppm	
En	Wide band noise	$I_k = 100\mu A, 10Hz < f < 10kHz$		35		nV/√Hz	

<sup>1.</sup> Limits are 100% production tested at 25°C. Behavior at temperature range limits is guaranteed by correlation and design.

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Electrical characteristics TS822

Figure 1. Reference voltage versus cathode Figure 2. Minimum operating current current



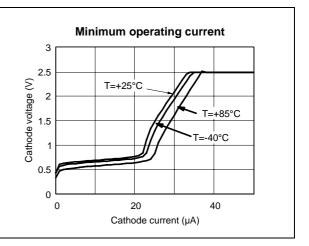
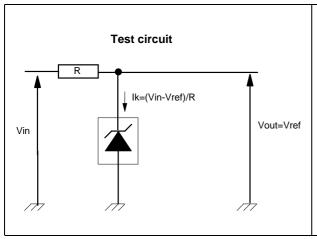


Figure 3. Test circuit

Figure 4. Reference voltage versus temperature



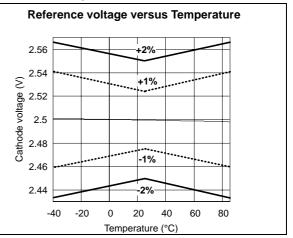
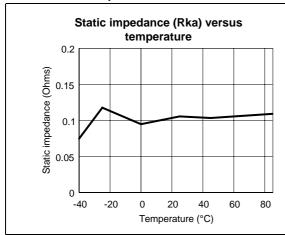
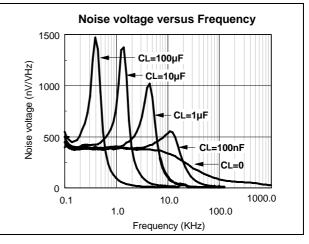


Figure 5. Static impedance (R<sub>ka</sub>) versus temperature

Figure 6. Noise voltage versus frequency

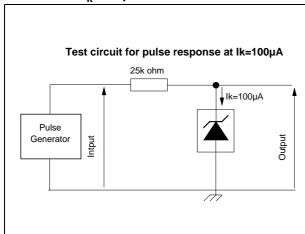




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Figure 7. Test circuit for pulse response at  $I_k=100\mu A$ 

Figure 8. Pulse response for  $I_k=100\mu A$ 



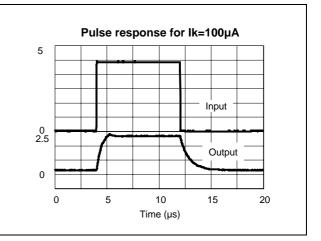
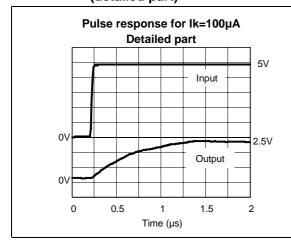


Figure 9. Pulse response for  $I_k=100\mu A$  (detailed part)

Figure 10. Pulse response for I<sub>k</sub>=100μA (detailed part)



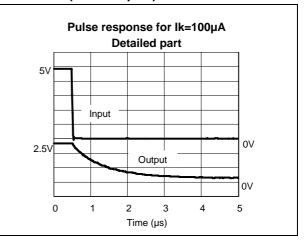
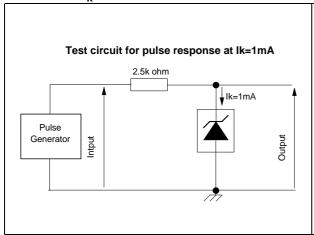
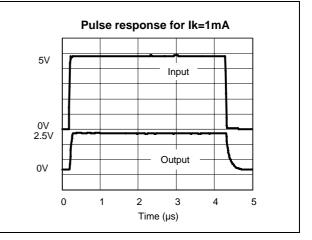


Figure 11. Test circuit for pulse response at  $I_k$ =100mA

Figure 12. Pulse response for I<sub>k</sub>=100mA



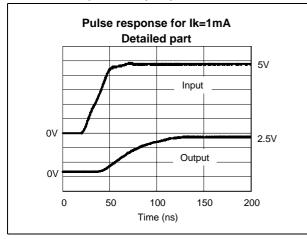


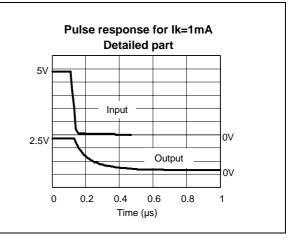
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Figure 13. Pulse response for I<sub>k</sub>=100mA (detailed part)

Figure 14. Pulse response for I<sub>k</sub>=100mA (detailed part)





## 3 Package information

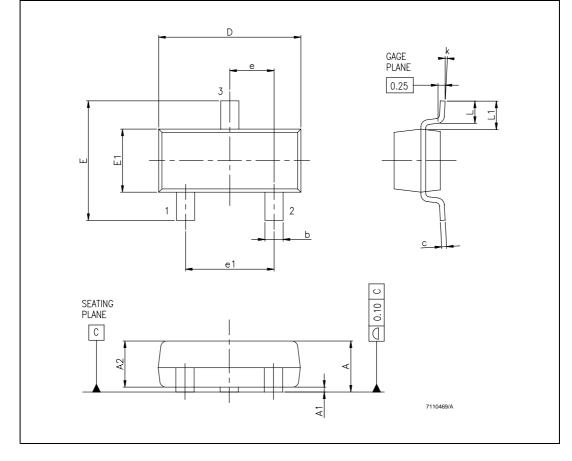
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TS822 Package information

Figure 15. SOT23-3 package mechanical data

	Dimensions						
Ref.	Millimeters			Mils			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	0.890		1.120	35.05		44.12	
A1	0.010		0.100	0.39		3.94	
A2	0.880	0.950	1.020	34.65	37.41	40.17	
b	0.300		0.500	11.81		19.69	
С	0.080		0.200	3.15		7.88	
D	2.800	2.900	3.040	110.26	114.17	119.72	
Е	2.100		2.64	82.70		103.96	
E1	1.200	1.300	1.400	47.26	51.19	55.13	
е		0.950			37.41		
e1		1.900			74.82		
L	0.400		0.600	15.75		23.63	
L1		0.540			21.27		
k	0°		8°	0°		8°	



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Ordering information TS822

# 4 Ordering information

Table 5. Order codes

Part number	Precision	Temperature range	Package	Packing	Marking
TS822ILT	2%	-40°C to +85°C	SOT23-3	Tape & reel	L223
TS822AILT	1%	-40 0 10 +65 0	30123-3	Tape & Teel	L222

# 5 Revision history

Table 6. Document revision history

Date	Revision	Changes
21-Mar-2002	1	Initial release.
20-Aug-2007 2		Removed information related to TO-92 package. Format update.

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